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1.

FORM PTO-1595

To the Director of the U.S. Paten

- Name of conveying pa 1. Takaaki MIYOSHI
- 2. Kazuya NODA

2. Name and Address of receiving party(ies):

> ASAHI KASEI CHEMICALS CORPORATION Hibiya-Mitsu Bldg. 1-2, Yuraku-cho 1-chome, Chiyoda-ku Tokyo, 100-8440 Japan

3. Nature of conveyance:

Assignment Merger <u>X</u> Security Agreement Change of Name Other:

Execution Date(s): January 31, 2008

Application number(s) or patent number(s): 4. This document is being filed together with a new application.

OR

- This document is being filed after filing of the application:
- (a) Patent Application No(s). 12/084897, filed May 13, 2008; or
- (b) Patent No(s). , issued .
- 5. Name and address of party to whom correspondence concerning document should be mailed: STAAS & HALSEY LLP Our Docket: 1830.1038 Attention: Mark J. Henry 1201 New York Ave., N.W., 7th Floor Washington, D.C. 20005
- 6. Total number of applications and patents involved: 1
- 7. Total fee (37 CFR 3.41)..... (\$ 40.00 per Patent or Application in Assignment) \boxtimes Enclosed Authorized to be charged to deposit account.
- 8. Deposit Account No.: 19-3935 (Any underpayment is authorized to be charged to this Deposit Account)

(Attach duplicate copy of this page if paying by deposit account)

Mark J. Henry, Reg. No. 36,162 Name of Person Signing

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Signature /	Da

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Revised January, 2005

PATENT REEL: 022286 FRAME: 0516

W3470-01(US)

ASSIGNMENT

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar(\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Asahi Kasei Chemicals Corporation, a corporation organized under the laws of Japan, located at 1-2, Yuraku-cho 1-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Asahi Kasei Chemicals Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith,

and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Asahi Kasei Chemicals Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Asahi Kasei Chemicals Corporation.

Signed on the date(s) indicated aside signatures: INVENTOR(S) Date Signed

(発明者フルネームサイン)

(署名日)

WITNESSES (立会人サイン)

RECORDED: 02/17/2009